# 8-Channel Differential DAS with 18-Bit, Bipolar, Simultaneous Sampling ADC 

## Data Sheet

## FEATURES

8 simultaneously sampled inputs
True differential inputs
True bipolar analog input ranges: $\pm \mathbf{2 0} \mathrm{V}, \pm \mathbf{1 0} \mathrm{V}$
Single 5 V analog supply and 2.3 V to 5.25 V VRIVE
Fully integrated data acquisition solution
Analog input clamp protection
Input buffer with 1 M $\Omega$ analog input impedance
Second-order antialiasing analog filter
On-chip accurate reference and reference buffer
18-bit ADC with 200 kSPS on all channels
Oversampling capability with digital filter
Flexible parallel/serial interface
SPI/QSPI ${ }^{\text {rM }} /$ MICROWIRE $^{\text {TM }} /$ DSP compatible
Performance
7 kV ESD rating on analog input channels
98 dB SNR, $\mathbf{- 1 0 7 ~ d B ~ T H D ~}$
Dynamic range: up to 105 dB typical
Low power: 100 mW
Standby mode: 25 mW
64-lead LQFP package

## APPLICATIONS

Power line monitoring and protection systems
Multiphase motor control
Instrumentation and control systems
Multiaxis positioning systems
Data acquisition systems (DAS)

## COMPANION PRODUCTS

External References: ADR421, ADR431
Digital Isolators: ADuM1402, ADuM5000, ADuM5402
Power: ADIsimPower, Supervisor Parametric Search
Additional companion products on the AD7609 product page
Table 1. High Resolution, Bipolar Input, Simultaneous
Sampling DAS Solutions

|  | Single- <br> Ended | True <br> Differential <br> Resolution | Number of <br> Simpltaneous <br> Sampling Channels |
| :--- | :--- | :--- | :--- |
| 18 Bits | AD7608 $^{1}$ | AD7609 | 8 |
| 16 Bits | AD7606B |  | 8 |
|  | AD7606 |  | 8 |
|  | AD7606-6 |  | 6 |
|  | AD7606-4 |  | 4 |
| 14 Bits | AD7607 |  | 8 |

${ }^{1}$ Protected by U.S. Patent Number 8,072,360.
FUNCTIONAL BLOCK DIAGRAM


Rev. D
Document Feedback

## TABLE OF CONTENTS

Features ..... 1
Applications ..... 1
Companion Products .....  1
Functional Block Diagram ..... 1
Revision History ..... 2
General Description ..... 3
Specifications ..... 4
Timing Specifications ..... 7
Absolute Maximum Ratings ..... 11
Thermal Resistance ..... 11
ESD Caution ..... 11
Pin Configuration and Function Descriptions ..... 12
Typical Performance Characteristics ..... 15
Terminology ..... 19
Theory of Operation ..... 21
REVISION HISTORY
8/2019—Rev. C to Rev. D
Changed $\pm 10 \mathrm{~V}$ to $\pm 20 \mathrm{~V}$ and $\pm 5 \mathrm{~V}$ to $\pm 10 \mathrm{~V}$ ..... Throughout
Changes to Table 1 .....  1
Changes to General Description Section ..... 3
Changes to Endnote 4, Table 2 ..... 6
Changes to Figure 8 through Figure 13 ..... 15
Changes to Figure 14 through Figure 19 ..... 16
Changes to Figure 20 through Figure 25 ..... 17
Changes to Figure 26, Figure 30, and Figure 31 ..... 18
Changes to Figure 34 Caption ..... 21
Changes to Figure 35 through Figure 37 ..... 22
Changes to Figure 54 and Figure 55 ..... 30
Changes to Figure 56 through Figure 59 ..... 31
Changes to Ordering Guide ..... 34
Converter Details ..... 21
Analog Input ..... 21
ADC Transfer Function. ..... 22
Internal/External Reference ..... 23
Typical Connection Diagram ..... 24
Power-Down Modes ..... 24
Conversion Control ..... 25
Digital Interface ..... 26
Parallel Interface ( $\overline{\mathrm{PAR}} / \mathrm{SER} \mathrm{SEL}=0$ ) ..... 26
Serial Interface $(\overline{\mathrm{PAR}} / \mathrm{SER} \mathrm{SEL}=1)$ ..... 26
Reading During Conversion ..... 27
Digital Filter ..... 28
Layout Guidelines ..... 32
Outline Dimensions ..... 34
Ordering Guide ..... 34
5/2018—Rev. B to Rev. C
Changes to Patent Note, Note 1 .....  1
Change to tconv Parameter, Table 3 .....  7
5/2014—Rev. A to Rev. B
Changes to Patent Footnote ..... 1
Changes to Figure 37 ..... 22
Changes to Figure 39 and Figure 40 ..... 23
2/2012-Rev. 0 to Rev. A
Changes to Analog Input Ranges Section ..... 21
7/2011—Revision 0: Initial Version

## AD7609

## GENERAL DESCRIPTION

The AD7609 is an 18-bit, 8-channel, true differential, simultaneous sampling analog-to-digital data acquisition system (DAS). The part contains analog input clamp protection, a second-order antialiasing filter, a track-and-hold amplifier, an 18-bit charge redistribution successive approximation analog-to-digital converter (ADC), a flexible digital filter, a 2.5 V reference and reference buffer, and high speed serial and parallel interfaces.

The AD7609 operates from a single 5 V supply and can accommodate $\pm 20 \mathrm{~V}$ and $\pm 10 \mathrm{~V}$ true bipolar differential input signals while sampling at throughput rates up to 200 kSPS for all channels. The input clamp protection circuitry can tolerate voltages up to $\pm 16.5 \mathrm{~V}$ on each analog input pin. The AD7609 has $1 \mathrm{M} \Omega$ analog input impedance regardless of sampling frequency. The single supply operation, on-chip filtering, and high input impedance eliminate the need for driver op amps and external bipolar supplies. The AD7609 antialiasing filter has a -3 dB cutoff frequency of 32 kHz and provides 40 dB antialias rejection when sampling at 200 kSPS . The flexible digital filter is pin driven, yields improvements in SNR, and reduces the -3 dB bandwidth.

## SPECIFICATIONS

$\mathrm{V}_{\text {Ref }}=2.5 \mathrm{~V}$ external/internal, $\mathrm{AV}_{\mathrm{CC}}=4.75 \mathrm{~V}$ to 5.25 V , $\mathrm{V}_{\text {DRIVE }}=2.3 \mathrm{~V}$ to 5.25 V ; $\mathrm{f}_{\mathrm{SAMPLE}}=200 \mathrm{kSPS}, \mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{MIN}}$ to $\mathrm{T}_{\mathrm{MAX}}$, unless otherwise noted. ${ }^{1}$

Table 2.


| Parameter | Test Conditions/Comments | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| ANALOG INPUT |  |  |  |  |  |
| Differential Input Voltage Ranges | $\mathrm{VIN}=\mathrm{Vx}+-(\mathrm{Vx}-)$ |  |  |  |  |
|  | RANGE $=1 ; \pm 20 \mathrm{~V}$ range | -20 |  | +20 | V |
|  | RANGE $=0 ; \pm 10 \mathrm{~V}$ range | -10 |  | +10 | V |
| Absolute Voltage Input | $\pm 20 \mathrm{~V}$ range, see the Analog Input Clamp Protection section $\pm 10$ V range, see the Analog Input Clamp Protection section | -10 |  | +10 | V |
|  |  | -5 |  | +5 | V |
| Common-Mode Input Range |  | -4 | $\pm 5$ | +4 | V |
| CMRR |  |  | -70 |  | dB |
| Analog Input Current |  |  | 5.4 |  | $\mu \mathrm{A}$ |
|  | $\pm 10 \mathrm{~V}$ range, see Figure 28 |  | 2.5 |  | $\mu \mathrm{A}$ |
| Input Capacitance ${ }^{7}$ |  |  | 5 |  | pF |
| Input Impedance |  |  | 1 |  |  |
| REFERENCE INPUT/OUTPUT |  |  |  |  |  |
| Reference Input Voltage Range |  | 2.475 | 2.5 | 2.525 | V |
| DC Leakage Current |  |  |  | $\pm 1$ | $\mu \mathrm{A}$ |
| Input Capacitance ${ }^{7}$ | REF SELECT $=1$ |  | 7.5 |  | pF |
| Reference Output Voltage | REFIN/REFOUT |  | $\begin{aligned} & 2.49 / \\ & 2.505 \end{aligned}$ |  |  |
| Reference Temperature Coefficient |  |  | $\pm 10$ |  | ppm $/{ }^{\circ} \mathrm{C}$ |
| LOGIC INPUTS |  |  |  |  |  |
| Input High Voltage ( $\mathrm{V}_{\text {INH }}$ ) |  | $0.7 \times \mathrm{V}_{\text {DRVE }}$ |  |  | V |
| Input Low Voltage ( $\mathrm{V}_{\text {INL }}$ ) |  |  |  | $0.3 \times \mathrm{V}_{\text {dRVE }}$ | V |
| Input Current (l\|w |  |  |  | $\pm 2$ | $\mu \mathrm{A}$ |
| Input Capacitance ( $\left.\mathrm{C}_{\text {IN }}\right)^{7}$ |  |  | 5 |  | pF |
| LOGIC OUTPUTS |  |  |  |  |  |
| Output High Voltage ( $\mathrm{V}_{\text {OH }}$ ) | $I_{\text {SoURCE }}=100 \mu \mathrm{~A}$ | $V_{\text {drive }}-0.2$ |  |  | V |
| Output Low Voltage (VoL) | $\mathrm{I}_{\text {SIINK }}=100 \mu \mathrm{~A}$ |  |  | 0.2 | V |
| Floating-State Leakage Current |  |  | $\pm 1$ | $\pm 20$ | $\mu \mathrm{A}$ |
| Floating-State Output Capacitance ${ }^{7}$ |  |  | 5 |  | pF |
| Output Coding | Twos complement |  |  |  |  |
| CONVERSION RATE |  |  |  |  |  |
| Conversion Time | All eight channels included |  | 4 |  | $\mu \mathrm{s}$ |
| Track-and-Hold Acquisition Time |  |  | 1 |  | $\mu \mathrm{s}$ |
| Throughput Rate | Per channel, all eight channels included |  |  | 200 | kSPS |
| POWER REQUIREMENTS |  |  |  |  |  |
| $\mathrm{AV}_{\text {cc }}$ |  | 4.75 |  | 5.25 | V |
| V ${ }_{\text {drive }}$ |  | 2.3 |  | 5.25 | V |
| 1 total | Digital inputs $=0 \mathrm{~V}$ or $\mathrm{V}_{\text {drive }}$ |  |  |  |  |
| Normal Mode (Static) |  |  | 16 | 22 | mA |
| Normal Mode (Operational) ${ }^{8}$ | $\mathrm{f}_{\text {SAMPLE }}=200 \mathrm{kSPS}$ |  | 20 | 28.5 | mA |
| Standby Mode |  |  | 5 | 8 | mA |
| Shutdown Mode |  |  | 2 | 11 | $\mu \mathrm{A}$ |


| Parameter | Test Conditions/Comments | Min | Typ | Max | Unit |
| :--- | :--- | :--- | :--- | :--- | :--- |
| Power Dissipation |  |  |  |  |  |
| Normal Mode (Static) |  | 80 | 115.5 | mW |  |
| Normal Mode (Operational) ${ }^{8}$ | fSAMPLE $=200 \mathrm{kSPS}$ | 100 | 157 | mW |  |
| Standby Mode |  | 25 | 42 | mW |  |
| Shutdown Mode |  | 10 | 60.5 | $\mu \mathrm{~W}$ |  |

${ }^{1}$ Temperature range for B version is $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
${ }^{2}$ See the Terminology section.
${ }^{3}$ This specification applies when reading during a conversion or after a conversion. If reading during a conversion in parallel and serial modes with $\mathrm{V}_{\mathrm{DRIVE}}=5 \mathrm{~V}$, SNR typically reduces by 1.5 dB and THD by 3 dB .
${ }^{4}$ LSB means least significant bit. With $\pm 10 \mathrm{~V}$ input range, $1 \mathrm{LSB}=76.29 \mu \mathrm{~V}$. With $\pm 20 \mathrm{~V}$ input range, $1 \mathrm{LSB}=152.58 \mu \mathrm{~V}$.
${ }^{5}$ These specifications include the full temperature range variation and contribution from the internal reference buffer but do not include the error contribution from the external reference.
${ }^{6}$ Bipolar zero code error is calculated with respect to the analog input voltage. See the Analog Input Clamp Protection section.
${ }^{7}$ Sample tested during initial release to ensure compliance.
${ }^{8}$ Operational power/current figure includes contribution when running in oversampling mode.

## TIMING SPECIFICATIONS

$\mathrm{AV}_{\mathrm{CC}}=4.75 \mathrm{~V}$ to $5.25 \mathrm{~V}, \mathrm{~V}_{\mathrm{DRIVE}}=2.3 \mathrm{~V}$ to $5.25 \mathrm{~V}, \mathrm{~V}_{\text {Ref }}=2.5 \mathrm{~V}$ external reference/ internal reference, $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{MIN}}$ to $\mathrm{T}_{\mathrm{MAX}}$, unless otherwise noted. ${ }^{1}$

Table 3.



| Parameter | Limit at Tmin, $\mathrm{Tmax}^{\text {m }}$ |  |  | Unit | Description |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max |  |  |
| $\mathrm{t}_{27}$ |  |  |  |  | Delay from $\overline{\mathrm{RD}}$ falling edge to FRSTDATA low |
|  |  |  | 22 | ns | $\mathrm{V}_{\text {DRIVE }}=3.3 \mathrm{~V}$ to 5.25 V |
|  |  |  | 29 | ns | $V_{\text {DRIVE }}=2.3 \mathrm{~V}$ to 2.7 V |
| $\mathrm{t}_{28}$ |  |  |  |  | Delay from $18^{\text {th }}$ SCLK falling edge to FRSTDATA low |
|  |  |  | 20 | ns | $\mathrm{V}_{\text {DRIVE }}=3.3 \mathrm{~V}$ to 5.25 V |
|  |  |  | 27 | ns | $V_{\text {DRIVE }}=2.3 \mathrm{~V}$ to 2.7 V |
| $\mathrm{t}_{29}$ |  |  | 29 | ns | Delay from $\overline{\mathrm{CS}}$ rising edge until FRSTDATA three-state enabled |

${ }^{1}$ Sample tested during initial release to ensure compliance. All input signals are specified with $\mathrm{t}_{\mathrm{R}}=\mathrm{t}_{\mathrm{F}}=5 \mathrm{~ns}\left(30 \%\right.$ to $70 \%$ of $\left.\mathrm{V}_{\mathrm{DD}}\right)$ and timed from a voltage level of 1.6 V .
${ }^{2}$ The delay between the CONVST x signals was measured as the maximum time allowed while ensuring a <40 LSB performance matching between channel sets.
${ }^{3} \mathrm{~A}$ buffer is used on the data output pins for these measurements, which is equivalent to a load of 20 pF on the output pins.

## Timing Diagrams



Figure 2. CONVST x Timing—Reading After a Conversion


Figure 4. Parallel Mode Separate $\overline{C S}$ and $\overline{R D}$ Pulses


## ABSOLUTE MAXIMUM RATINGS

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.
Table 4.

| Parameter | Rating |
| :--- | :--- |
| $\mathrm{AV}_{\text {CC }}$ to AGND | -0.3 V to +7 V |
| $\mathrm{~V}_{\text {DRIVE }}$ to AGND | -0.3 V to $\mathrm{AV} \mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}$ |
| Analog Input Voltage to $A G N D^{1}$ | $\pm 16.5 \mathrm{~V}$ |
| Digital Input Voltage to AGND | -0.3 V to $\mathrm{V}_{\text {DRIVE }}+0.3 \mathrm{~V}$ |
| Digital Output Voltage to AGND | -0.3 V to $\mathrm{V}_{\text {DRIV }}+0.3 \mathrm{~V}$ |
| REFIN to AGND | -0.3 V to AV CC +0.3 V |
| Input Current to Any Pin Except | $\pm 10 \mathrm{~mA}$ |
| $\quad$ Supplies |  |
| Operating Temperature Range |  |
| $\quad$ B Version | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Junction Temperature | $150^{\circ} \mathrm{C}$ |
| Pb/SN Temperature, Soldering |  |
| $\quad$ Reflow (10 sec to 30 sec) | $240(+0)^{\circ} \mathrm{C}$ |
| Pb-Free Temperature, Soldering Reflow | $260(+0)^{\circ} \mathrm{C}$ |
| ESD (All Pins Except Analog Inputs) | 2 kV |
| ESD (Analog Input Pins Only) | 7 kV |

${ }^{1}$ Transient currents of up to 100 mA do not cause SCR latch-up.
Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

## THERMAL RESISTANCE

$\theta_{\mathrm{JA}}$ is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages. These specifications apply to a 4-layer board.

Table 5. Thermal Resistance

| Package Type | $\theta_{\mathrm{JA}}$ | $\boldsymbol{\theta}_{\mathrm{sc}}$ | Unit |
| :--- | :--- | :--- | :--- |
| 64-Lead LQFP | 45 | 11 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## ESD CAUTION

|  | ESD (electrostatic discharge) sensitive device. <br> Charged devices and circuit boards can discharge <br> without detection. Although this product features <br> patented or proprietary protection circuitry, damage <br> may occur on devices subjected to high energy ESD. <br> Therefore, proper ESD precautions should be taken to <br> avoid performance degradation or loss of functionality. |
| :--- | :--- |

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Figure 7. Pin Configuration

Table 6. Pin Function Descriptions

| Pin No. | Type ${ }^{1}$ | Mnemonic | Description |
| :---: | :---: | :---: | :---: |
| 1,37, 38, 48 | P | $\mathrm{AV}_{\text {cc }}$ | Analog Supply Voltage 4.75 V to 5.25 V . This supply voltage is applied to the internal front-end amplifiers and to the ADC core. These supply pins should be decoupled to AGND. |
| $\begin{aligned} & 2,26,35 \\ & 40,41,47 \end{aligned}$ | P | AGND | Analog Ground. This pin is the ground reference point for all analog circuitry on the AD7609. All analog input signals and external reference signals should be referred to these pins. All six of these AGND pins should connect to the AGND plane of a system. |
| 23 | P | $V_{\text {drive }}$ | Logic Power Supply Input. The voltage ( 2.3 V to 5 V ) supplied at this pin determines the operating voltage of the interface. This pin is nominally at the same supply as the supply of the host interface (that is, DSP, FPGA). |
| 36,39 | P | REGCAP | Decoupling Capacitor Pins for Voltage Output from Internal Regulator. These output pins should be decoupled separately to AGND using a $1 \mu \mathrm{~F}$ capacitor. The voltage on these output pins is in the range of 2.5 V to 2.7 V . |
| $\begin{aligned} & 49,51,53, \\ & 55,57,59, \\ & 61,63 \end{aligned}$ | Al+ | V1+ to V8+ | Analog Input V1+ to Analog Input V8+. These pins are the positive terminal of the true differential analog inputs. The analog input range of these channels is determined by the RANGE pin. |
| $\begin{aligned} & 50,52,54, \\ & 56,58,60, \\ & 62,64 \end{aligned}$ | Al- | V1- to V8- | Analog Input V1- to Analog Input V8-. These are the negative terminals of the true differential analog inputs. The analog input range of these channels is determined by the RANGE pin. The signal on this pin should be $180^{\circ}$ out of phase with the corresponding $\mathrm{Vx}+$ pin. |
| 42 | REF | REFIN/ REFOUT | Reference Input/ Reference Output. The on-chip reference of 2.5 V is available on this pin for external use if the REF SELECT pin is set to a logic high. Alternatively, the internal reference can be disabled by setting the REF SELECT pin to a logic low and an external reference of 2.5 V can be applied to this input. See the Internal/External Reference section. Decoupling is required on this pin for both the internal or external reference options. A $10 \mu \mathrm{~F}$ capacitor should be applied from this pin to ground close to the REFGND pins. |
| 34 | DI | REF SELECT | Internal/External Reference Selection Input. Logic input. If this pin is set to logic high, the internal reference is selected and is enabled. If this pin is set to logic low, the internal reference is disabled and an external reference voltage must be applied to the REFIN/REFOUT pin. |
| 44,45 | REF | REFCAPA, REFCAPB | Reference Buffer Output Force/Sense Pins. These pins must be connected together and decoupled to AGND using a low ESR $10 \mu \mathrm{~F}$ ceramic capacitor. |
| 43,46 | REF | REFGND | Reference Ground Pins. These pins should be connected to AGND. |


| Pin No. | Type ${ }^{1}$ | Mnemonic | Description |
| :---: | :---: | :---: | :---: |
| 8 | DI | RANGE | Analog Input Range Selection. Logic input. The polarity on this pin determines the input range of the analog input channels. If this pin is tied to a logic high, the analog input range is $\pm 20 \mathrm{~V}$ for all channels. If this pin is tied to a logic low, the analog input range is $\pm 10 \mathrm{~V}$ for all channels. A logic change on this pin has an immediate effect on the analog input range. Changing this pin during a conversion is not recommended. See the Analog Input section for more details. |
| 6 | DI | $\overline{\text { PAR/ }}$ SER SEL | Parallel/Serial Interface Selection Input. Logic input. If this pin is tied to a logic low, the parallel interface is selected. If this pin is tied to a logic high, the serial interface is selected. <br> In serial mode, the $\overline{R D} /$ SCLK pin functions as the serial clock input. The DB7/DoutA and DB8/DoutB pins function as serial data outputs. <br> When the serial interface is selected, the $\mathrm{DB}[15: 9]$ and $D B[6: 0]$ pins should be tied to AGND. |
| 9, 10 | DI | CONVST A, CONVST B | Conversion Start Input A, Conversion Start Input B. Logic inputs. These logic inputs are used to initiate conversions on the analog input channels. For simultaneous sampling of all input channels, CONVST A and CONVST B can be shorted together and a single conversion start signal applied. Alternatively, CONVST A can be used to initiate simultaneous sampling for $\mathrm{V} 1, \mathrm{~V} 2, \mathrm{~V} 3$, and V 4 , and CONVST B can be used to initiate simultaneous sampling on the other analog inputs (V5, V6, V7, and V8). This is only possible when oversampling is not switched on. When the CONVST A or CONVST B pin transitions from low to high, the front-end track-and-hold circuitry for their respective analog inputs is set to hold. This function allows a phase delay to be created inherently between the sets of analog inputs. |
| 13 | DI | $\overline{C S}$ | Chip Select. This active low logic input frames the data transfer. When both $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are logic low in parallel mode, the output bus ( $\mathrm{DB}[15: 0]$ ) is enabled and the conversion result is output on the parallel data bus lines. In serial mode, the $\overline{C S}$ is used to frame the serial read transfer and clocks out the MSB of the serial output data. |
| 12 | DI | $\overline{\mathrm{RD}} / \mathrm{SCLK}$ | Parallel Data Read Control Input When Parallel Interface is Selected ( $\overline{\mathrm{RD}}) /$ Serial Clock Input When Serial Interface is Selected (SCLK). When both $\overline{C S}$ and $\overline{R D}$ are logic low in parallel mode, the output bus is enabled. In parallel mode, two $\overline{\mathrm{RD}}$ pulses are required to read the full 18 bits of conversion results from each channel. The first $\overline{\mathrm{RD}}$ pulse outputs $\mathrm{DB}[17: 2]$, and the second $\overline{\mathrm{RD}}$ pulses outputs $\mathrm{DB}[1: 0]$. In serial mode, this pin acts as the serial clock input for data transfers. The $\overline{\mathrm{CS}}$ falling edge takes the data output lines, DoutA and DouTB, out of three-state and clocks out the MSB of the conversion result. The rising edge of SCLK clocks all subsequent data bits onto the serial data outputs, Dout A and DoutB. For further information, see the Conversion Control section. |
| 14 | DO | BUSY | Busy Output. This pin transitions to a logic high after both CONVST A and CONVST B rising edges and indicates that the conversion process has started. The BUSY output remains high until the conversion process for all channels is complete. The falling edge of BUSY signals that the conversion data is being latched into the output data registers and will be available to be read after a time, t . Any data read while BUSY is high should be complete before the falling edge of BUSY occurs. Rising edges on CONVST A or CONVST B have no effect while the BUSY signal is high. |
| 11 | DI | RESET | Reset Input. When set to logic high, the rising edge of RESET resets the AD7609. The part must receive a RESET pulse after power-up. To achieve the specified performance after the RESET signal, the twaKE_Up shutdown time should elapse between power-on and the RESET pulse. The RESET high pulse should be typically 100 ns wide. If a RESET pulse is applied during a conversion, the conversion is aborted. If a RESET pulse is applied during a read, the contents of the output registers reset to all zeros. |
| 15 | DO | FRSTDATA | Digital Output. The FRSTDATA output signal indicates when the first channel, V 1 , is being read back on either the parallel or serial interface. When the $\overline{C S}$ input is high, the FRSTDATA output pin is in three-state. The falling edge of $\overline{C S}$ takes FRSTDATA out of three-state. In parallel mode, the falling edge of $\overline{\mathrm{RD}}$ corresponding to the result of V 1 then sets the FRSTDATA pin high, indicating that the result from V 1 is available on the output data bus. The FRSTDATA output returns to a logic low following the third falling edge of $\overline{R D}$. In serial mode, FRSTDATA goes high on the falling edge of $\overline{C S}$ as this clocks out the MSB of V1 on DOUTA. It returns low on the 18th SCLK falling edge after the $\overline{C S}$ falling edge. See the Conversion Control section for more details. |
| 7 | DI | $\overline{\text { STBY }}$ | Standby Mode Input. This pin is used to place the AD7609 into one of two power-down modes: standby mode or shutdown mode. The power-down mode entered depends on the state of the RANGE pin, as shown in Table 8. When in standby mode, all circuitry except the on-chip reference, regulators, and regulator buffers is powered down. When in shutdown mode, all circuitry is powered down. |


| Pin No. | Type ${ }^{1}$ | Mnemonic | Description |
| :---: | :---: | :---: | :---: |
| 5,4,3 | DI | OS [2:0] | Oversampling Mode Pins. Logic inputs. These inputs are used to select the oversampling ratio. OS 2 is the MSB control bit, and OS 0 is the LSB control bit. See the Digital Filter section for additional details on the oversampling mode of operation and Table 9 for oversampling bit decoding. |
| 33 | DO/DI | DB15 | Parallel Output Data Bits, Data Bit 15. When $\overline{\mathrm{PAR}} / \mathrm{SER} \mathrm{SEL}=0$, this pin acts as three-state parallel digital output pin. This pin is used to output DB17 of the conversion result during the first $\overline{\mathrm{RD}}$ pulse and DB1 of the same conversion result during the second $\overline{\mathrm{RD}}$ pulse. When $\overline{\mathrm{PAR}} / \mathrm{SER}$ SEL $=1$, this pin should be tied to AGND. |
| 32 | DO/DI | DB14 | Parallel Output Data Bits, Data Bit 14. When $\overline{\mathrm{PAR}} / \mathrm{SER}$ SEL $=0$, this pin acts as three-state parallel digital output pin. When $\overline{C S}$ and $\overline{\mathrm{RD}}$ are low, this pin is used to output DB16 of the conversion result during the first $\overline{\mathrm{RD}}$ pulse and DBO of the same conversion result during the second $\overline{\mathrm{RD}}$ pulse. When $\overline{\mathrm{PAR}} / \mathrm{SER}$ SEL $=1$, this pin should be tied to AGND. |
| 31 to 27 | DO | DB[13:9] | Parallel Output Data Bits, Data Bit 13 to Data Bit 9. When $\overline{\text { PAR }} /$ SER SEL $=0$, these pins act as three-state parallel digital input/output pins. When $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are low, these pins are used to output DB15 to DB11 of the conversion result during the first $\overline{\mathrm{RD}}$ pulse and output 0 during the second $\overline{\mathrm{RD}}$ pulse. When $\overline{\mathrm{PAR}} / \mathrm{SER}$ SEL $=1$, these pins should be tied to AGND. |
| 24 | DO | DB7/DoutA | Parallel Output Data Bit 7 (DB7)/Serial Interface Data Output Pin (DoutA). When $\overline{\text { PAR }} / \mathrm{SER}$ SEL $=0$, this pin acts as a three-state parallel digital input/output pin. When $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are low, this pin is used to output DB9 of the conversion result. When $\overline{\mathrm{PAR}} / \mathrm{SER}$ SEL $=1$, this pin functions as DoutA and outputs serial conversion data. See the Conversion Control section for further details. |
| 25 | DO | DB8/DoutB | Parallel Output Data Bit 8 (DB8)/Serial Interface Data Output Pin (DourB). When $\overline{\mathrm{PAR}} / \mathrm{SER}$ SEL $=0$, this pin acts as a three-state parallel digital input/output pin. When $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are low, this pin is used to output DB10 of the conversion result. When $\overline{\text { PAR }} /$ SER SEL $=1$, this pin functions as DoutB and outputs serial conversion data. See the Conversion Control section for further details. |
| 22 to 16 | DO | DB[6:0] | Parallel Output Data Bits, Data Bit 6 to Data Bit 0 . When $\overline{\text { PAR }} /$ SER SEL $=0$, these pins act as three-state parallel digital input/output pins. When $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are low, these pins are used to output DB8 to DB2 of the conversion result during the first $\overline{\mathrm{RD}}$ pulse and output 0 during the second $\overline{\mathrm{RD}}$ pulse. When $\overline{\mathrm{PAR}} / \mathrm{SER}$ SEL $=1$, these pins should be tied to AGND. |

[^0]
## TYPICAL PERFORMANCE CHARACTERISTICS



Figure 8. FFT Plot, $\pm 20$ V Range


Figure 9. FFT Plot, $\pm 10$ V Range


Figure 10. FFT Plot, $\pm 20$ V Range


Figure 11. Typical INL, $\pm 20$ V Range


Figure 12. Typical DNL, $\pm 20$ V Range


Figure 13. Typical INL, $\pm 10 \mathrm{~V}$ Range


Figure 14. Typical DNL, $\pm 10$ V Range


Figure 15. NFS Error vs. Temperature


Figure 16. PFS Error vs. Temperature


Figure 17. NFS and PFS Error Matching


Figure 18. PFS and NFS Error vs. Source Resistance


Figure 19. SNR vs. Input Frequency, $\pm 20$ V Range


Figure 20. SNR vs. Input Frequency, $\pm 10 \mathrm{~V}$ Range


Figure 21. THD vs. Input Frequency for Various Source Impedances, $\pm 20$ V Range


Figure 22. THD vs. Input Frequency for Various Source Impedances, $\pm 10$ V Range


Figure 23. Bipolar Zero Code Error vs. Temperature


Figure 24. Bipolar Zero Code Error Matching Between Channels


Figure 25. Channel-to-Channel Isolation


Figure 26. Dynamic Range vs. Oversampling Ratio


Figure 27. Reference Output Voltage vs. Temperature for Different Supply Voltages


Figure 28. Analog Input Current vs. Input Voltage Over Temperature


Figure 29. Supply Current vs. Oversampling Rate


Figure 30. PSRR


Figure 31. CMRR vs. Common-Mode Ripple Frequency

## TERMINOLOGY

## Integral Nonlinearity

The maximum deviation from a straight line passing through the endpoints of the ADC transfer function. The endpoints of the transfer function are zero scale, a ${ }^{1 / 2}$ LSB below the first code transition, and full scale at $1 / 2$ LSB above the last code transition.

## Differential Nonlinearity

The difference between the measured and the ideal 1 LSB change between any two adjacent codes in the ADC.

## Bipolar Zero Code Error

The deviation of the midscale transition (all 1s to all $0 s$ ) from the ideal VIN voltage, that is, AGND.

## Bipolar Zero Code Error Match

The difference in bipolar zero code error between any two input channels.

## Positive Full-Scale Error

The last transition (from $011 \ldots 10$ to $011 \ldots 11$ in twos complement coding) should occur for an analog voltage $1^{11 / 2}$ LSB below the nominal full scale ( 9.99977 V for the $\pm 10 \mathrm{~V}$ range and 4.99988 V for the $\pm 5 \mathrm{~V}$ range). The positive full-scale error is the deviation of the actual level of the last transition from the ideal level.

## Positive Full-Scale Error Match

The difference in positive full-scale error between any two input channels.

## Negative Full-Scale Error

The first transition (from $100 \ldots 00$ to $100 \ldots 01$ in twos complement coding) should occur for an analog voltage $1 / 2$ LSB above the negative full scale ( -9.999923 V for the $\pm 10 \mathrm{~V}$ range and -4.9999618 for the $\pm 5 \mathrm{~V}$ range). The negative full-scale error is the deviation of the actual level of the first transition from the ideal level.

## Negative Full-Scale Error Match

The difference in negative full-scale error between any two input channels.

## Track-and-Hold Acquisition Time

The track-and-hold amplifier returns to track mode at the end of the conversion. The track-and-hold acquisition time is the time required for the output of the track-and-hold amplifier to reach its final value, within $\pm 1 \mathrm{LSB}$, after the end of the conversion. See the Track-and-Hold Amplifiers section for more details.

## Signal-to-(Noise + Distortion) Ratio

The measured ratio of signal-to-(noise + distortion) at the output of the ADC. The signal is the rms amplitude of the fundamental. Noise is the sum of all nonfundamental signals up to half the sampling frequency ( $\mathrm{f}_{\mathrm{s}} / 2$, excluding dc). The ratio depends on the number of quantization levels in the digitization process: the more levels, the smaller the quantization noise. The theoretical signal-to-(noise + distortion) ratio for an ideal N-bit converter with a sine wave input is given by

$$
\text { Signal-to-(Noise }+ \text { Distortion })=(6.02 N+1.76) \mathrm{dB}
$$

Thus, for an 18 -bit converter, this is 110.12 dB .

## Total Harmonic Distortion (THD)

The ratio of the rms sum of the harmonics to the fundamental. For the AD7609, it is defined as

$$
\begin{aligned}
& \operatorname{THD}(\mathrm{dB})= \\
& 20 \log \frac{\sqrt{V_{2}^{2}+V_{3}^{2}+V_{4}^{2}+V_{5}^{2}+V_{6}^{2}+V_{7}^{2}+V_{8}^{2}+V_{9}^{2}}}{V_{1}}
\end{aligned}
$$

where:
$V_{1}$ is the rms amplitude of the fundamental.
$V_{2}$ to $V_{9}$ are the rms amplitudes of the second through ninth harmonics.

## Peak Harmonic or Spurious Noise

The ratio of the rms value of the next largest component in the ADC output spectrum (up to $\mathrm{f}_{\mathrm{s}} / 2$, excluding dc) to the rms value of the fundamental. Normally, the value of this specification is determined by the largest harmonic in the spectrum, but for ADCs where the harmonics are buried in the noise floor, it is determined by a noise peak.

## Intermodulation Distortion

With inputs consisting of sine waves at two frequencies, fa and fb , any active device with nonlinearities creates distortion products at sum and difference frequencies of $\mathrm{mfa} \pm \mathrm{nfb}$, where $\mathrm{m}, \mathrm{n}=0$, $1,2,3$. Intermodulation distortion terms are those for which neither $m$ nor $n$ is equal to 0 . For example, the second-order terms include ( $\mathrm{fa}+\mathrm{fb}$ ) and ( $\mathrm{fa}-\mathrm{fb}$ ), and the third-order terms include $(2 \mathrm{fa}+\mathrm{fb})$, $(2 \mathrm{fa}-\mathrm{fb}),(\mathrm{fa}+2 \mathrm{fb})$, and $(\mathrm{fa}-2 \mathrm{fb})$.
The calculation of the intermodulation distortion is per the THD specification, where it is the ratio of the rms sum of the individual distortion products to the rms amplitude of the sum of the fundamentals expressed in decibels (dB).

## Power Supply Rejection (PSR)

Variations in power supply affect the full-scale transition but not the converter's linearity. Power supply rejection is the maximum change in full-scale transition point due to a change in power supply voltage from the nominal value. The power supply rejection ratio is defined as the ratio of the power in the ADC output at full-scale frequency, f , to the power of a 200 mV p-p sine wave applied to the ADC VDD and Vss supplies of Frequency fs.

$$
P S R R(\mathrm{~dB})=10 \log \left(P f / P f_{s}\right)
$$

where:
$P f$ is equal to the power at Frequency f in the ADC output. $P f_{s}$ is equal to the power at Frequency $f_{S}$ coupled onto the $V_{D D}$ and $V_{\text {ss }}$ supplies.

## Channel-to-Channel Isolation

Channel-to-channel isolation is a measure of the level of crosstalk between any two channels. It is measured by applying a full-scale, 10 kHz sine wave signal to all unselected input channels and determining the degree to which the signal attenuates in the selected channel with a 1 kHz signal.

## Common-Mode Rejection Ratio (CMRR)

CMRR is defined as the ratio of the power in the ADC common-mode input at full-scale frequency, f , to the power in the output of a full-scale p-p sine wave applied to the commonmode voltage of $\mathrm{V}_{\text {IN }} \mathrm{X}+$ and $\mathrm{V}_{\text {IN }} \mathrm{X}$ - of frequency, $\mathrm{f}_{\mathrm{s}}$,

$$
C M R R(\mathrm{~dB})=20 \log \left(P f / P f_{s}\right)
$$

where:
$P f$ is equal to the power at Frequency f in the ADC input. $P f_{s}$ is equal to the power at Frequency $\mathrm{f}_{\mathrm{s}}$ in the ADC output.

## THEORY OF OPERATION

## CONVERTER DETAILS

The AD7609 is a data acquisition system that employs a high speed, low power, charge redistribution successive approximation analog-to-digital converter (ADC) and allows the simultaneous sampling of eight true differential analog input channels. The analog inputs on the AD7609 can accept true bipolar input signals. The RANGE pin is used to select either $\pm 20 \mathrm{~V}$ or $\pm 10 \mathrm{~V}$ as the input range. The AD7609 operates from a single 5 V supply.

The AD7609 contains input clamp protection, input signal scaling amplifiers, a second-order antialiasing filter, track-andhold amplifiers, an on-chip reference, reference buffers, a high speed ADC, a digital filter, and high speed parallel and serial interfaces. Sampling on the AD7609 is controlled using CONVST x signals.

## ANALOG INPUT

## Analog Input Ranges

The AD7609 can handle true bipolar input voltages. The logic level on the RANGE pin determines the analog input range of all analog input channels. If this pin is tied to a logic high, the analog input range is $\pm 20 \mathrm{~V}$ for all channels. If this pin is tied to a logic low, the analog input range is $\pm 10 \mathrm{~V}$ for all channels. A logic change on this pin has an immediate effect on the analog input range; however, there is a settling time of $80 \mu \mathrm{~s}$ typically, in addition to the normal acquisition time requirement. The recommended practice is to hardwire the RANGE pin according to the desired input range for the system signals.
During normal operation, the applied analog input voltage should remain within the analog input range selected via the RANGE pin. A RESET pulse must be applied to the part to ensure the analog input channels are configured for the range selected.
When in a power-down mode, it is recommended to tie the analog inputs together or both analog input pins ( $\mathrm{Vx}+, \mathrm{Vx}-$ ) to GND. As per the Analog Input Clamp Protection section, the overvoltage clamp protection is recommended for use in transient overvoltage conditions, and should not remain active for extended periods. Stressing the analog inputs outside of these conditions may degrade the Bipolar Zero Code error and THD performance of the AD7609.

## Analog Input Impedance

The analog input impedance of the AD7609 is $1 \mathrm{M} \Omega$. This is a fixed input impedance and does not vary with the AD7609 sampling frequency. This high analog input impedance eliminates the need for a driver amplifier in front of the AD7609 allowing for direct connection to the source or sensor. With the need for a driver amplifier eliminated, bipolar supplies can be removed from the signal chain, which are often a source of noise in a system.

## Analog Input Clamp Protection

Figure 32 shows the analog input structure of the AD7609. Each AD7609 analog input contains clamp protection circuitry. Despite a single 5 V supply operation, this analog input clamp protection allows for an input overvoltage up to $\pm 16.5 \mathrm{~V}$.


Figure 32. Analog Input Circuitry
Figure 33 shows the current vs. voltage characteristic of the clamp circuit. For input voltages up to $\pm 16.5 \mathrm{~V}$, no current flows in the clamp circuit. For input voltages above $\pm 16.5 \mathrm{~V}$, the AD7609 clamp circuitry turns on and clamps the analog input to $\pm 16.5 \mathrm{~V}$. A series resister should be placed on the analog input channels to limit the current to $\pm 10 \mathrm{~mA}$ for input voltages above $\pm 16.5 \mathrm{~V}$. In an application where there is a series resistance on an analog input channel, VINx + , a corresponding resistance is required on the VINx- channel (see Figure 34). If there is no corresponding resister on the Vx - channel, this results in an offset error on that channel. It is recommended that the input overvoltage clamp protection circuitry be used to protect the AD7609 against transient overvoltage events. It is not recommended to leave the AD7609 in a condition where the clamp protection circuitry is active (in normal or power-down conditions) for extended periods because this may degrade the bipolar zero code error performance of the AD7609.


Figure 33. Input Protection Clamp Profile


[^1]
## Analog Input Antialiasing Filter

An analog antialiasing filter is also provided on the AD7609. The filter is a second-order Butterworth. Figure 35 and Figure 36 show the frequency and phase response respectively of the analog antialiasing filter. In the $\pm 10 \mathrm{~V}$ range, the -3 dB frequency is typically 23 kHz . In the $\pm 20 \mathrm{~V}$ range, the -3 dB frequency is typically 32 kHz .


Figure 35. Analog Antialiasing Filter Frequency Response


Figure 36. Analog Antialiasing Filter Phase Response

## Track-and-Hold Amplifiers

The track-and-hold amplifiers on the AD7609 allow the ADC to accurately acquire an input sine wave of full-scale amplitude to 18 -bit resolution. The track-and-hold amplifiers sample their respective inputs simultaneously on the rising edge of CONVST x. The aperture time for track-and-hold (that is, the delay time between the external CONVST x signal and the track-and-hold actually going into hold) is well matched, by design, across all eight track-and-holds on one device and from device to device. This matching allows more than one AD7609 device to be sampled simultaneously in a system.

The end of the conversion process across all eight channels is indicated by the falling edge of BUSY; and it is at this point that the track-and-holds return to track mode and the acquisition time for the next set of conversions begins.

The conversion clock for the part is internally generated, and the conversion time for all channels is $4 \mu \mathrm{~s}$ on the AD7609. The BUSY signal returns low after all eight conversions to indicate the end of the conversion process. On the falling edge of BUSY, the track-and-hold amplifiers return to track mode. New data can be read from the output register via the parallel or serial interface after BUSY goes low; or, alternatively, data from the previous conversion can be read while BUSY is high. Reading data from the AD7609 while a conversion is in progress has little effect on performance and allows a faster throughput to be achieved. With a $V_{\text {DRIVE }}>3.3 \mathrm{~V}$, the SNR is reduced by $\sim 1.5 \mathrm{~dB}$ when reading during a conversion.

## ADC TRANSFER FUNCTION

The output coding of the AD7609 is twos complement. The designed code transitions occur midway between successive integer LSB values, that is, $1 / 2 \mathrm{LSB}, 3 / 2 \mathrm{LSB}$. The LSB size is FSR/262,144 for the AD7609. The FSR for the AD7609 is 40 V for the $\pm 20 \mathrm{~V}$ range and 20 V for the $\pm 10 \mathrm{~V}$ range. The ideal transfer characteristic for the AD7609 is shown in Figure 37.

$$
\begin{aligned}
& \pm 20 \mathrm{~V} \text { CODE }=\frac{\mathrm{V}+ \pm(\mathrm{V}-)}{20 \mathrm{~V}} \times 131,072 \times \frac{\mathrm{REF}}{2.5 \mathrm{~V}} \\
& \pm 10 \mathrm{~V} \text { CODE }=\frac{\mathrm{V}+ \pm(\mathrm{V}-)}{10 \mathrm{~V}} \times 131,072 \times \frac{\mathrm{REF}}{2.5 \mathrm{~V}}
\end{aligned}
$$



Figure 37. AD7609 Transfer Characteristic
The LSB size is dependent on the analog input range selected (see Table 7).

Table 7. Output Codes and Ideal Input Values

|  | Analog Input <br> $(\mathbf{V}+-(\mathbf{V}-)$ <br> $\mathbf{2 0}$ V Range | Analog <br> Input <br> V+ - (V-) <br> $\mathbf{1 0}$ V Range | Digital <br> Output <br> Code (Hex) |
| :--- | :--- | :--- | :--- |
| Description | +19.99992 V | 9.999961 V | $0 \times 1 \mathrm{FFFF}$ |
| FSR -0.5 LSB | $76 \mu \mathrm{~V}$ | $0 \times 00001$ |  |
| Midscale +1 LSB | $+152.58 \mu \mathrm{~V}$ | 0 V | $0 \times 00000$ |
| Midscale | 0 V | $-76 \mu \mathrm{~V}$ | $0 \times 3 F F F F$ |
| Midscale -1 LSB | $-152.58 \mu \mathrm{~V}$ | -9.99992 V | $0 \times 20001$ |
| $-\mathrm{FSR}+1 \mathrm{LSB}$ | -19.99984 V | -10 V | $0 \times 20000$ |

## INTERNAL/EXTERNAL REFERENCE

The AD7609 contains an on-chip 2.5 V band gap reference. The REFIN/REFOUT pin allows access to the 2.5 V reference that generates the on-chip 4.5 V reference internally, or it allows an external reference of 2.5 V to be applied to the AD7609. An externally applied reference of 2.5 V is also amplified to 4.5 V using the internal buffer. This 4.5 V buffered reference is the reference used by the SAR ADC.
The REF SELECT pin is a logic input pin that allows the user to select between the internal reference and the external reference. If this pin is set to logic high, the internal reference is selected and is enabled; if this pin is set to logic low, the internal reference is disabled and an external reference voltage must be applied to the REFIN/REFOUT pin. The internal reference buffer is always enabled. After a reset, the AD7609 operates in the reference mode selected by the REF SELECT pin. Decoupling is required on the REFIN/REFOUT pin for both the internal or external reference options. A $10 \mu \mathrm{~F}$ ceramic capacitor is required on the REFIN/REFOUT to ground close to the REFGND pins. The AD7609 contains a reference buffer configured to amplify the REF voltage up to $\sim 4.5 \mathrm{~V}$, as shown in Figure 38. The REFCAPA and REFCAPB pins must be shorted together externally and a ceramic capacitor of $10 \mu \mathrm{~F}$ applied to REFGND to ensure the reference buffer is in closed-loop operation. The reference voltage available at the REFIN/REFOUT pin is 2.5 V .
When the AD7609 is configured in external reference mode, the REFIN/REFOUT pin is a high input impedance pin. For applications using multiple AD7609 devices, the following configurations are recommended depending on the application requirements.

## External Reference Mode

One ADR421 external reference can be used to drive the REFIN/REFOUT pins of all AD7609 devices (see Figure 39). In this configuration, each AD7609 REFIN/REFOUT pin should be decoupled with a 100 nF decoupling capacitor.

## Internal Reference Mode

One AD7609 device, configured to operate in the internal reference mode, can be used to drive the remaining AD7609 devices, which are configured to operate in external reference mode (see Figure 40). The REFIN/REFOUT pin of the AD7609, configured in internal reference mode, should be decoupled using a $10 \mu \mathrm{~F}$ ceramic decoupling capacitor. The other AD7609 devices, configured in external reference mode, should use a 100 nF decoupling capacitor on their REFIN/REFOUT pins.


Figure 38. Reference Circuitry


Figure 39. Single External Reference Driving Multiple AD7609 REFIN/REFOUT Pins


Figure 40. Internal Reference Driving Multiple AD7609 REFIN Pins

## TYPICAL CONNECTION DIAGRAM

Figure 41 shows the typical connection diagram for the AD7609. There are four $A V_{C C}$ supply pins on the part that can be tied together and decoupled using a 100 nF capacitor at each supply pin and a $10 \mu \mathrm{~F}$ capacitor at the supply source. The AD7609 can operate with the internal reference or an externally applied reference. In this configuration, the AD7609 is configured to operate with the internal reference. When using a single AD7609 device on the board, the REFIN/REFOUT pin should be decoupled with a $10 \mu \mathrm{~F}$ capacitor. In an application with multiple AD7609 devices, see the Internal/External Reference section. The REFCAPA and REFCAPB pins are shorted together and decoupled with a $10 \mu \mathrm{~F}$ ceramic capacitor.
The $V_{\text {DRIve }}$ supply is connected to the same supply as the processor. The voltage on $V_{\text {DRIVE }}$ controls the voltage value of the output logic signals. For layout, decoupling, and grounding hints, see the Layout Guidelines section.

After supplies are applied to the AD7609, a reset should be applied to the AD7609 to ensure that it is configured for the correct mode of operation.

## POWER-DOWN MODES

There are two power-down modes available on the AD7609. The STBY pin controls whether the AD7609 is in normal mode or one of the two power-down modes. The two power-down modes available are standby mode and shutdown mode. The power-down mode is selected through the state of the RANGE pin when the $\overline{\text { STBY }}$ pin is low. Table 8 shows the configurations required to choose the desired power-down mode. When the AD7609 is placed in standby mode, the current consumption is 8 mA maximum and power-up time is approximately $100 \mu \mathrm{~s}$ because the capacitor on the REFCAPA/REFCAPB pins must charge up. In standby mode, the on-chip reference and regulators remain powered up and the amplifiers and ADC core are powered down. When the AD7609 is placed in shutdown mode, the current consumption is $11 \mu \mathrm{~A}$ maximum and power up time is about 13 ms . In shutdown mode, all circuitry is powered down. When the AD7609 is powered up from shutdown mode, a reset signal must be applied to the AD7609 after the required power-up time has elapsed.

Table 8. Power-Down Mode Selection

| Power-Down Mode | $\overline{\text { STBY }}$ | RANGE |
| :--- | :--- | :--- |
| Standby | 0 | 1 |
| Shutdown | 0 | 0 |


${ }^{1}$ decoupling shown On The AV CC PIN APPLIES TO EACH AV CC PIN (PIN 1, PIN 37, PIN 38, PIN 48). DECOUPLING CAPACITOR CAN BE SHARED BETWEEN AV ${ }_{\text {CC }}$ PIN 37 AND PIN 38.
${ }^{2}$ DECOUPLING SHOWN ON THE REGCAP PIN APPLIES TO EACH REGCAP PIN (PIN 36, PIN 39).
Figure 41. Typical Connection Diagram

## CONVERSION CONTROL

## Simultaneous Sampling on All Analog Input Channels

The AD7609 allows simultaneous sampling of all analog input channels. All channels are sampled simultaneously when both CONVST x pins (CONVST A, CONVST B) are tied together. A single CONVST x signal is used to control both CONVST $x$ inputs. The rising edge of this common CONVST x signal initiates simultaneous sampling on all analog input channels.
The AD7609 contains an on-chip oscillator that is used to perform the conversions. The conversion time for all ADC channels is tconv. The BUSY signal indicates to the user when conversions are in progress, so that when the rising edge of CONVST $x$ is applied, BUSY goes logic high and transitions low at the end of the entire conversion process. The falling edge of the BUSY signal is used to place all eight track-and-hold amplifiers back into track mode. The falling edge of BUSY also indicates that the new data can now be read from the parallel bus ( $\mathrm{DB}[15: 0]$ ) or the serial data lines, $\mathrm{D}_{\text {out }} \mathrm{A}$ and $\mathrm{D}_{\text {out }} \mathrm{B}$.

## Simultaneously Sampling Two Sets of Channels

The AD7609 also allows the analog input channels to be sampled simultaneously in two sets. This can be used in power line protection and measurement systems to compensate for phase differences between PT and CT transformers. In a 50 Hz system, this allows for up to $9^{\circ}$ of phase compensation, and in a 60 Hz system, it allows for up to $10^{\circ}$ of phase compensation.
This is accomplished by pulsing the two CONVST x pins independently and is only possible if oversampling is not in use. CONVST A is used to initiate simultaneous sampling of the first set of channels (V1 to V4). CONVST B is used to initiate simultaneous sampling on the second set of analog input channels (V5 to V8), as illustrated in Figure 42. On the rising edge of CONVST A, the track-and-hold amplifiers for the first set of channels are placed into hold mode. On the rising edge of CONVST B, the track-and-hold amplifiers for the second set of channels are placed into hold mode. The conversion process begins after both rising edges of CONVST x have occurred; therefore, BUSY goes high on the rising edge of the later CONVST x signal. The falling edge of BUSY also indicates that the new data can now be read from the parallel bus or the serial data lines, $\mathrm{D}_{\text {out }}$ A and DoutB. There is no change to the data read process when using two separate CONVST x signals.
Connect all unused analog input channel to AGND. The results for any unused channels are still included in the data read because all channels are always converted.


Figure 42. Simultaneous Sampling on Channel Sets Using Independent CONVST A/CONVST B Signals—Parallel Mode

## DIGITAL INTERFACE

The AD7609 provides two interface options: a parallel interface and a high speed serial interface. The required interface mode is selected via the $\overline{\mathrm{PAR}} /$ SER SEL pin.
The operation of the interface modes is described in the following sections.

## PARALLEL INTERFACE ( $\overline{\text { PAR } / S E R ~ S E L ~=~ 0) ~}$

Data can be read from the AD7609 via the parallel data bus with standard $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ signals. To read the data over the parallel bus, the $\overline{\mathrm{PAR}} /$ SER SEL pin should be tied low. The $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ input signals are internally gated to enable the conversion result onto the data bus. The data lines, DB 15 to DB 0 , leave their high impedance state when both $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are logic low.
The rising edge of the $\overline{\mathrm{CS}}$ input signal three-states the bus and the falling edge of the $\overline{\mathrm{CS}}$ input signal takes the bus out of the high impedance state. $\overline{\mathrm{CS}}$ is the control signal that enables the data lines; it is the function that allows multiple AD7609 devices to share the same parallel data bus. The $\overline{\mathrm{CS}}$ signal can be permanently tied low, and the $\overline{\mathrm{RD}}$ signal can be used to access the conversion results, as shown in Figure 4. A read operation of new data can take place after the BUSY signal goes low (Figure 2), or, alternatively, a read operation of data from the previous conversion process can take place while BUSY is high (Figure 3).
The $\overline{\mathrm{RD}}$ pin is used to read data from the output conversion results register. Two $\overline{\mathrm{RD}}$ pulses are required to read the full 18-bit conversion result from each channel. Applying a sequence of $16 \overline{\mathrm{RD}}$ pulses to the AD7609 $\overline{\mathrm{RD}}$ pin clocks the conversion results out from each channel onto the parallel output bus, $\mathrm{DB}[15: 0]$, in ascending order. The first $\overline{\mathrm{RD}}$ falling edge after BUSY goes low clocks out $\mathrm{DB}[17: 2]$ of the V1 result, and the next $\overline{\mathrm{RD}}$ falling edge updates the bus with $\mathrm{DB}[1: 0]$ of the V1 result. It takes $16 \overline{\mathrm{RD}}$ pulses to read the eight 18-bit conversion results from the AD7609. The $16^{\text {th }}$ falling edge of $\overline{\mathrm{RD}}$ clocks out the $\mathrm{DB}[1: 0]$ conversion result for Channel V8. When the $\overline{\mathrm{RD}}$ signal is logic low, it enables the data conversion result from each channel to be transferred to the digital host (DSP, FPGA).
When there is only one AD7609 in a system/board and it does not share the parallel bus, data can be read using only one control signal from the digital host. The $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ signals can be tied together, as shown in Figure 5. In this case, the data bus comes out of three-state on the falling edge of $\overline{\mathrm{CS}} / \overline{\mathrm{RD}}$. The combined $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ signal allows the data to be clocked out of the AD7609 and to be read by the digital host. In this case, $\overline{\mathrm{CS}}$ is used to frame the data transfer of each data channel and $16 \overline{\mathrm{CS}}$ pulses are required to read the eight channels of data.


Figure 43. AD7609 Interface Diagram: One AD7609 Using the Parallel Bus; $\overline{C S}$ and $\overline{R D}$ Shorted Together

## SERIAL INTERFACE ( $\overline{\text { PAR }} /$ SER SEL = 1)

To read data back from the AD7609 over the serial interface, the $\overline{\mathrm{PAR}} /$ SER SEL pin should be tied high. The $\overline{\mathrm{CS}}$ and SCLK signals are used to transfer data from the AD7609. The AD7609 has two serial data output pins, $\mathrm{D}_{\text {out }} \mathrm{A}$ and $\mathrm{D}_{\text {out }} B$. Data can be read back from the AD7609 using one or both of these Dout lines. For the AD7609, conversion results from Channel V1 to Channel V4 first appear on DoutA, whereas conversion results from Channel V5 to Channel V8 first appear on DoutB. The $\overline{\mathrm{CS}}$ falling edge takes the data output lines ( $\mathrm{Dout}_{\mathrm{A}}$ and Dout B) out of three-state and clocks out the MSB of the conversion result. The rising edge of SCLK clocks all subsequent data bits onto the serial data outputs, DoutA and DoutB. The $\overline{\mathrm{CS}}$ input can be held low for the entire serial read or it can be pulsed to frame each channel read of 18 SCLK cycles.
Figure 44 shows a read of eight simultaneous conversion results using two Dout lines on the AD7609. In this case, a 72 SCLK transfer is used to access data from the AD7609 and $\overline{\mathrm{CS}}$ is held low to frame the entire 72 SCLK cycles. Data can also be clocked out using only one Dout line, in which case Dout A is recommended to access all conversion data, because the channel data is output in ascending order. For the AD7609 to access all eight conversion results on one Dout line, a total of 144 SCLK cycles are required. These 144 SCLK cycles can be framed by one $\overline{\mathrm{CS}}$ signal or each group of 18 SCLK cycles can be individually framed by the $\overline{\mathrm{CS}}$ signal. The disadvantage of using only one Dout line is that the throughput rate is reduced if reading after conversion. The unused Dout line should be left unconnected in serial mode. For the AD7609, if $\mathrm{D}_{\text {out }} \mathrm{B}$ is to be used as a single Dout line, the channel results are output in the following order: V5, V6, V7, V8, V1, V2, V3, V4; however, the FRSTDATA indicator returns low after V5 is read on DoutB.

Figure 6 shows the timing diagram for reading one channel of data, framed by the $\overline{\mathrm{CS}}$ signal, from the AD7609 in serial mode. The SCLK input signal provides the clock source for the serial read operation. $\overline{\mathrm{CS}}$ goes low to access the data from the AD7609. The falling edge of $\overline{\mathrm{CS}}$ takes the bus out of three-state and clocks out the MSB of the 18 -bit conversion result. This MSB is valid on the first falling edge of the SCLK after the $\overline{\mathrm{CS}}$ falling edge. The subsequent 17 data bits are clocked out of the AD7609 on the SCLK rising edge. Data is valid on the SCLK falling edge. Eighteen clock cycles must be provided to the AD7609 to access each conversion result.
The FRSTDATA output signal indicates when the first channel, V1, is being read back. When the $\overline{\mathrm{CS}}$ input is high, the FRSTDATA output pin is in three-state. In serial mode, the falling edge of $\overline{\mathrm{CS}}$ takes FRSTDATA out of three-state and sets the FRSTDATA pin high indicating that the result from V1 is available on the Dout A output data line. The FRSTDATA output returns to a logic low following the $18^{\text {th }}$ SCLK falling edge. If all channels are
read on $\mathrm{D}_{\text {out }} \mathrm{B}$, the FRSTDATA output does not go high when V 1 is being output on this serial data output pin. It only goes high when V1 is available on Dout A (and this is when V5 is available on $\mathrm{D}_{\text {out }} \mathrm{B}$ ).

## READING DURING CONVERSION

Data can be read from the AD7609 while BUSY is high and conversions are in progress. This has little effect on the performance of the converter and allows a faster throughput rate to be achieved. A parallel or serial read can be performed during conversions and when oversampling may or may not be in use. Figure 3 shows the timing diagram for reading while BUSY is high in parallel or serial mode. Reading during conversions allows the full throughput rate to be achieved when using the serial interface with a $V_{\text {DRIVE }}$ of 3.3 V to 5.25 V .

Data can be read from the AD7609 at any time other than on the falling edge of BUSY because this is when the output data registers are updated with the new conversion data. $t_{6}$, outlined in Table 3, should be observed in this condition.


Figure 44. AD7609 Serial Interface with Two Dout Lines

## DIGITAL FILTER

The AD7609 contains an optional digital filter. This digital filter is a first-order sinc filter. This digital filter should be used in applications where slower throughput rates are used or where higher signal-to-noise ratio or dynamic range is desirable. The oversampling ratio of the digital filter is controlled using the oversampling pins, OS [2:0] (see Table 9). OS 2 is the MSB control bit and OS 0 is the LSB control bit. Table 9 provides the oversampling bit decoding to select the different oversample rates. The OS pins are latched on the falling edge of BUSY. This sets the oversampling rate for the next conversion (see
Figure 45). In addition to the oversampling function, the output result is decimated to 18 -bit resolution.

If the OS pins are set to select an OS ratio of 8, the next CONVST x rising edge takes the first sample for each channel and the remaining seven samples for all channels are taken with an internally generated sampling signal. These samples are then averaged to yield an improvement in SNR performance. Table 9 shows typical SNR performance for both the $\pm 20 \mathrm{~V}$ and the $\pm 10 \mathrm{~V}$ ranges. As Table 9 indicates, there is an improvement in SNR as the OS ratio increases. As the OS ratio increases, the 3 dB frequency is reduced and the allowed sampling frequency is also reduced. In an application where the required sampling frequency is 10 kSPS , an OS ratio of up to 16 can be used. In this case, the application sees an improvement in SNR but the input -3 dB bandwidth is limited to $\sim 6 \mathrm{kHz}$.

The CONVST A and CONVST B pins must be tied/driven together when oversampling is turned on. When the oversampling function is turned on, the BUSY high time for the conversion process extends. The actual BUSY high time depends on the oversampling rate selected; the higher the oversampling rate, the longer the BUSY high, or total conversion time, see Table 9.

Figure 46 shows that the conversion time extends as the oversampling rate is increased, and the BUSY signal lengthens for the different oversampling rates. For example, a sampling frequency of 10 kSPS yields a cycle time of $100 \mu \mathrm{~s}$. Figure 46 shows $\mathrm{OS} \times 2$ and OS $\times 4$; for a 10 kSPS example, there is adequate cycle time to further increase the oversampling rate and yield greater improvements in SNR performance. In an application where the initial sampling or throughput rate is at 200 kSPS , for example, and oversampling is turned on, the throughput rate must be reduced to accommodate the longer conversion time and to allow for the read. To achieve the fastest throughput rate possible when oversampling is turned on, the read can be performed during the BUSY high time. The falling edge of BUSY is used to update the output data registers with the new conversion data; therefore, the reading of conversion data should not occur on this edge. Figure 47 to Figure 53 illustrate the effect of oversampling on the code spread in a dc histogram plot. As the oversample rate is increased, the spread of codes is reduced. (In Figure 47 to Figure 53, $\mathrm{AV}_{\mathrm{cc}}=\mathrm{V}_{\mathrm{DRIVE}}=5 \mathrm{~V}$ and the sampling rate was scaled with OS ratio.)


Table 9. Oversampling Bit Decoding ( 100 Hz Input Signal)

| $\begin{aligned} & \text { OS } \\ & {[2: 0]} \end{aligned}$ | OS Ratio | $\begin{aligned} & \text { SNR } \pm 10 \mathrm{~V} \\ & \text { Range (dB) } \end{aligned}$ | $\text { SNR } \pm 20 \mathrm{~V} \text { Range }$ (dB) | $\begin{aligned} & \hline-3 \mathrm{~dB} \text { BW } 10 \mathrm{~V} \\ & \text { Range (kHz) } \end{aligned}$ | $\begin{aligned} & \hline-3 \mathrm{~dB} \text { BW } 20 \mathrm{~V} \\ & \text { Range (kHz) } \\ & \hline \end{aligned}$ | Maximum Throughput CONVST x Frequency (kHz) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 000 | No OS | 90.8 | 91.5 | 22 | 33 | 200 |
| 001 | 2 | 93.3 | 93.9 | 22 | 28.9 | 100 |
| 010 | 4 | 95.5 | 96.4 | 18.5 | 21.5 | 50 |
| 011 | 8 | 98 | 98.9 | 11.9 | 12 | 25 |
| 100 | 16 | 100.6 | 101 | 6 | 6 | 12.5 |
| 101 | 32 | 101.8 | 102 | 3 | 3 | 6.25 |
| 110 | 64 | 102.7 | 102.9 | 1.5 | 1.5 | 3.125 |
| 111 | Invalid |  |  |  |  |  |



Figure 46. AD7609—No Oversampling, Oversampling $\times 4$, and Oversampling $\times 8$ Using Read After Conversion


Figure 47. Histogram of Codes-No OS (19 Codes)


Figure 48. Histogram of Codes-OS $\times 2$ (15 Codes)


Figure 49. Histogram of Codes-OS $\times 4$ (10 Codes)


Figure 50. Histogram of Codes—OS $\times 8$ (Eight Codes)


Figure 51. Histogram of Codes-OS $\times 16$ (Six Codes)


Figure 52. Histogram of Codes-OS $\times 32$ (Four Codes)


Figure 53. Histogram of Codes - OS $\times 64$ (Four Codes)

When the oversampling mode is selected, this has the effect of adding a digital filter function after the ADC. The different oversampling rates and the CONVST x sampling frequency produces different digital filter frequency profiles.

Figure 54 to Figure 59 show the digital filter frequency profiles for the different oversampling rates. The combination of the analog antialiasing filter and the oversampling digital filter can be used to eliminate or reduce the complexity of the design of the filter before the AD7609. The digital filtering combines steep roll-off and linear phase response.


Figure 54. Digital Filter Response for $O S \times 2$


Figure 55. Digital Filter Response for OS $\times 4$


Figure 56. Digital Filter Response for $O S \times 8$


Figure 57. Digital Filter Response for $\mathrm{OS} \times 16$


Figure 58. Digital Filter Response for $\mathrm{OS} \times 32$


Figure 59. Digital Filter Response for OS $\times 64$

## LAYOUT GUIDELINES

The printed circuit board that houses the AD7609 should be designed so that the analog and digital sections are separated and confined to different areas of the board.

Use at least one ground plane. It can be common or split between the digital and analog sections. In the case of the split plane, the digital and analog ground planes should be joined in only one place, preferably as close as possible to the AD7609.
If the AD7609 is in a system where multiple devices require analog-to-digital ground connections, the connection should still be made at only one point, a star ground point, which should be established as close as possible to the AD7609. Good connections should be made to the ground plane. Avoid sharing one connection for multiple ground pins. Individual vias or multiple vias to the ground plane should be used for each ground pin.
Avoid running digital lines under the devices because doing so couples noise onto the die. Allow the analog ground plane to run under the AD7609 to avoid noise coupling. Shield fastswitching signals like CONVST A, CONVST B, or clocks with digital ground to avoid radiating noise to other sections of the board, and they should never run near analog signal paths. Avoid crossover of digital and analog signals. Run traces on layers in close proximity on the board at right angles to each other to reduce the effect of feedthrough through the board.
The power supply lines to the $A V_{C C}$ and $V_{\text {DRIVE }}$ pins on the AD7609 should use as large a trace as possible to provide low impedance paths and reduce the effect of glitches on the power supply lines. Where possible, use supply planes. Good connections should be made between the AD7609 supply pins and the power tracks on the board; this should involve the use of a single via or multiple vias for each supply pin.

Good decoupling is also important to lower the supply impedance presented to the AD7609 and to reduce the magnitude of the supply spikes. Place the decoupling capacitors close to, ideally right up against, these pins and their corresponding ground pins. Place the decoupling capacitors for the REFIN/ REFOUT pin and the REFCAPA and REFCAPB pins as close as possible to their respective AD7609 pins. Where possible, they should be placed on the same side of the board as the AD7609 device. Figure 60 shows the recommended decoupling on the top layer of the AD7609 board. Figure 61 shows bottom layer decoupling. Bottom layer decoupling is for the four $A V_{C C}$ pins and the $V_{\text {DRIVE }}$ pin.


Figure 60. Top Layer Decoupling REFIN/REFOUT, REFCAPA, REFCAPB, and REGCAP Pins


Figure 61. Bottom Layer Decoupling

To ensure good device-to-device performance matching in a system that contains multiple AD7609 devices, a symmetrical layout between the AD7609 devices is important. Figure 62 shows a layout with two AD7609 devices. The AV CC supply plane runs to the right of both devices. The $\mathrm{V}_{\text {DRIVE }}$ supply track runs to the left of the two AD7609 devices. The reference chip is positioned between both AD7609 devices and the reference voltage track runs north to Pin 42 of U1 and south to Pin 42 to U2. A solid ground plane is used. These symmetrical layout principles can be applied to a system that contains more than two AD7609 devices. The AD7609 devices can be placed in a north-to-south direction with the reference voltage located midway between the AD7609 devices and the reference track running in the north-to-south direction similar to Figure 62.


Figure 62. Multiple AD7609 Layout, Top Layer and Supply Plane Layer

## OUTLINE DIMENSIONS



| ORDERING GUIDE | Temperature Range | Package Description | Package Option |
| :--- | :--- | :--- | :--- |
| Model $^{1}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $64-$ Lead Low Profile Quad Flat Package [LQFP] | ST-64-2 |
| AD7609BSTZ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 64-Lead Low Profile Quad Flat Package [LQFP] | ST-64-2 |
| AD7609BSTZ-RL |  | Evaluation Board for the AD7609 |  |
| EVAL-AD7609EDZ | Converter Evaluation Development |  |  |
| EVAL-CED1Z |  |  |  |

${ }^{1} Z=$ RoHS Compliant Part.
Data Sheet AD7609

NOTES

## NOTES

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Разъемы специального, военного и аэрокосмического назначения:
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[^0]:    ${ }^{1}$ Refers to classification of pin type; P denotes power, Al denotes analog input, REF denotes reference, DI denotes digital input, DO denotes digital output.

[^1]:    Figure 34. Input Resistance Matching on the Analog Input ( $\pm 20$ V Range)

